

Philips

Diode BY559X-1500U

Datasheet

Silicon Diode

BY559X-1500U

1500V/10A

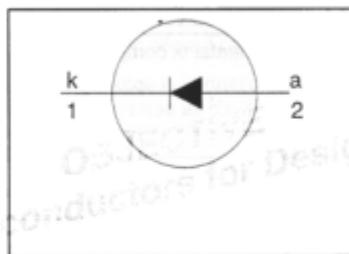
DATASHEET

OEM – Philips

Source: Philips Databook 1999

**Damper diode
fast, high-voltage**
BY559X-1500U
FEATURES

- Low forward volt drop
- Low forward recovery voltage
- Fast switching
- Soft recovery characteristic
- High thermal cycling performance
- Isolated mounting tab

SYMBOL**QUICK REFERENCE DATA**

$V_R = 1500 \text{ V}$
$V_F \leq 1.4 \text{ V}$
$V_{fr} \leq 10 \text{ V}$
$t_{rr} \leq 120 \text{ ns}$
$I_{F(Peak)} = 10 \text{ A}$
$I_{FSM} \leq 150 \text{ A}$

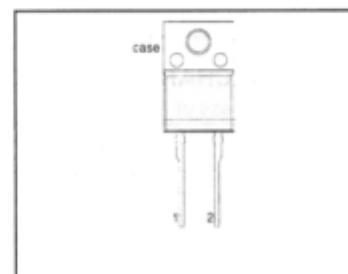
GENERAL DESCRIPTION

A double diffused rectifier diode in a plastic envelope, featuring fast forward and reverse recovery and low forward voltage. The device is intended for use as a damper diode in horizontal deflection circuits of large screen monitors and workstations.

The BY559X series is supplied in the conventional leaded SOD113 package.

PINNING

PIN	DESCRIPTION
1	cathode
2	anode
tab	isolated

SOD113**LIMITING VALUES**

Limiting values in accordance with the Absolute Maximum System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V_{RRM}	Peak repetitive reverse voltage		-	1500	V
V_{RWM}	Crest working reverse voltage		-	1300	V
$I_{F(Peak)}$	Peak working forward current		-	10	A
I_{FRM}	Peak repetitive forward current		-	150	A
I_{FSM}	Peak non repetitive forward current		-	160	A
$T_{Storage}$	Storage temperature		-40	150	°C
T_J	Operating junction temperature	$f = 130 \text{ kHz}; t = 100 \mu\text{s}$ $t = 10 \text{ ms}$ sinusoidal; $T_i = 150 \text{ °C}$ prior to surge; with reapplied $V_{RWM(max)}$	-	150	°C

ISOLATION LIMITING VALUE & CHARACTERISTIC

$T_{hs} = 25 \text{ °C}$ unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V_{isol}	R.M.S. isolation voltage from both terminals to external heatsink	$f = 50-60 \text{ Hz}$; sinusoidal waveform; R.H. $\leq 65\%$; clean and dustfree	-		2500	V
C_{isol}	Capacitance from both terminals to external heatsink	$f = 1 \text{ MHz}$	-	10	-	pF

Damper diode
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THERMAL RESISTANCES

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$R_{th\ j-hs}$	Thermal resistance junction to heatsink	with heatsink compound	-	-	3.6	K/W
$R_{th\ j-a}$	Thermal resistance junction to ambient	in free air.	-	55	-	K/W

STATIC CHARACTERISTICS $T_j = 25^\circ\text{C}$ unless otherwise stated

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V_F	Forward voltage	$I_F = 6.5 \text{ A}$	-	1.5	1.8	V
I_R	Reverse current	$I_F = 6.5 \text{ A}; T_j = 125^\circ\text{C}$ $V_R = V_{RWMax}$ $V_R = V_{RWMax}; T_j = 125^\circ\text{C}$	- - -	1.2 - -	1.4 0.5 2.0	V mA mA

DYNAMIC CHARACTERISTICS $T_j = 25^\circ\text{C}$ unless otherwise stated

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V_{tr}	Forward recovery voltage	$I_F = 6.5; dI_F/dt = 50 \text{ A}/\mu\text{s}$	-	6	10	V
t_{fr}	Forward recovery time	$I_F = 6.5 \text{ A}; dI_F/dt = 50 \text{ A}/\mu\text{s}; V_F = 5 \text{ V}$	-	130	180	ns
t_{rr}	Reverse recovery time	$I_F = 1 \text{ A}; -dI_F/dt = 50 \text{ A}/\mu\text{s}; V_R \geq 30 \text{ V}$	-	90	120	ns
Q_s	Reverse recovery charge	$I_F = 2 \text{ A}; -dI_F/dt = 20 \text{ A}/\mu\text{s}; V_R \geq 30 \text{ V}$	-	0.2	0.25	μC